

RoHS Compliant Product
A suffix of "-C" specifies halogen free

FEATURES

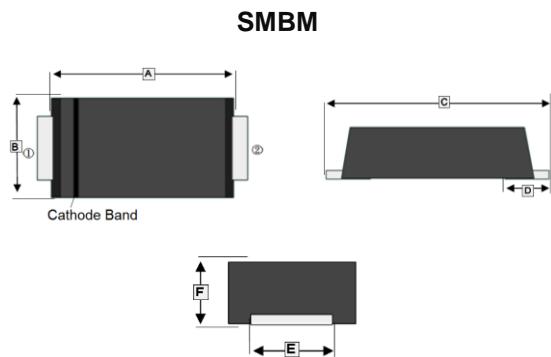
- Metal silicon junction, majority carrier conduction
- For surface mounted applications
- Low power loss, high efficiency
- High forward surge current capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications

MECHANICAL DATA

- Case: SMBM
- Terminals: Solderable per MIL-STD-750, Method 2026

MARKING

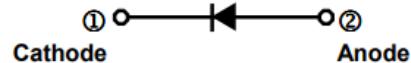
SL510B



REF.	Millimeter		REF.	Millimeter	
	Min.	Max.		Min.	Max.
A	4.20	4.70	E	1.80	2.20
B	3.40	3.80	F	1.10	1.45
C	5.10	5.50	G	0.18	0.26
D	1.00	REF.			

PACKAGE INFORMATION

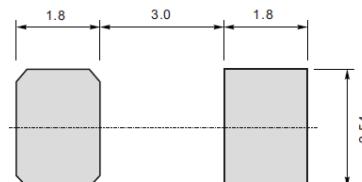
Package	MPQ	Leader Size
SMBM	5K	13 inch



ORDER INFORMATION

Part Number	Type
SK5100BM-C	Lead (Pb)-free and Halogen-free

Mounting Pad Layout



*Dimensions in millimeters

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(Rating 25°C ambient temperature unless otherwise specified. Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, de-rate current by 20%.)

Parameter	Symbol	Rating	Unit
Maximum Recurrent Peak Reverse Voltage	V _{RRM}	100	V
Working Peak Reverse Voltage	V _{RSM}	70	V
Maximum DC Blocking Voltage	V _{DC}	100	V
Maximum Average Forward Rectified Current	I _F	5	A
Peak Forward Surge Current @8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I _{FSM}	150	A
Typical Thermal Resistance from Junction-Ambient ²	R _{θJA}	60	°C/W
Operating & Storage Temperature Range	T _J , T _{STG}	-55~150	°C

ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Typ.	Max.	Unit	Test Condition
Maximum Forward Voltage	V _F	-	0.6	V	I _F =5A, T _A =25°C
Maximum DC Reverse Current at Rated DC Blocking Voltage	I _R	-	0.1	mA	T _A =25°C
Typical Junction Capacitance ¹	C _J	180	-	pF	

Notes:

1. Measured at 1MHz and applied reverse voltage of 4V D.C.
2. P.C.B. mounted with 2.0" x 2.0" (5x5 cm) copper pad areas.

RATINGS AND CHARACTERISTIC CURVES

Fig.1 Forward Current Derating Curve

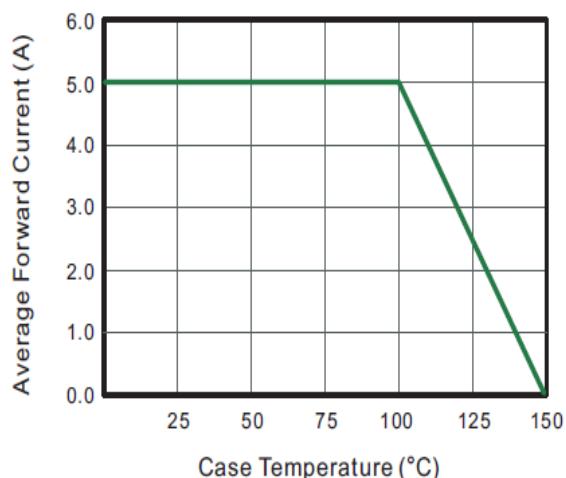


Fig.2 Typical Reverse Characteristics

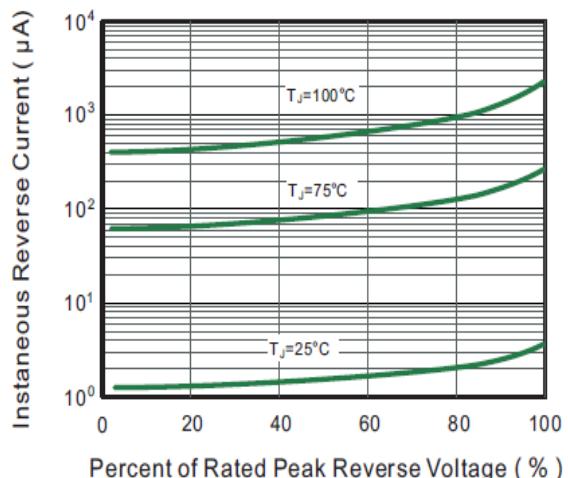


Fig.3 Typical Forward Characteristic

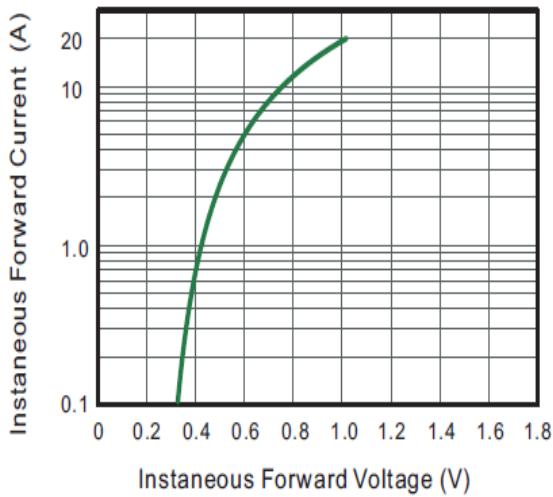


Fig.4 Typical Junction Capacitance

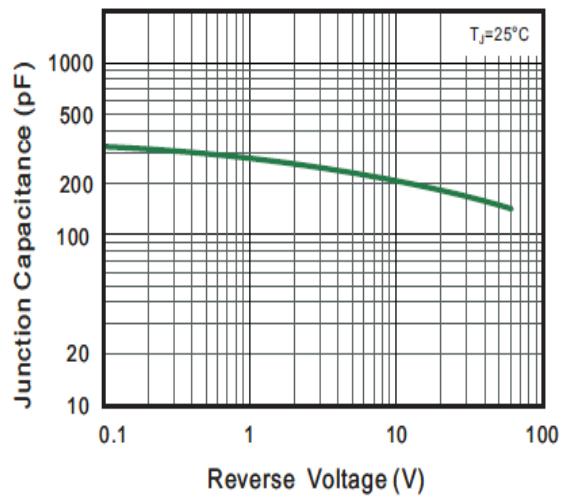


Fig.5 Maximum Non-Repetitive Peak Forward Surge Current

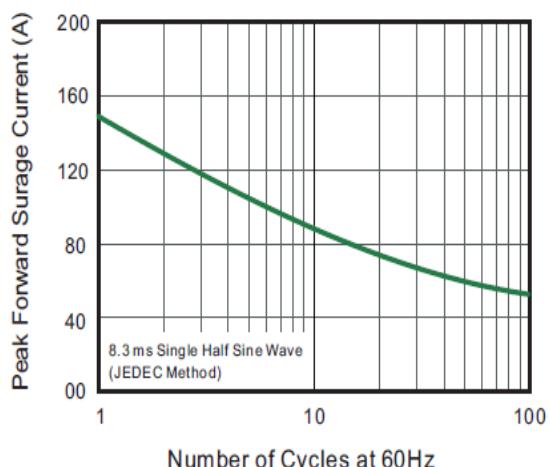


Fig.6-Typical Transient Thermal Impedance

